



**12500 TI Boulevard, MS 8640, Dallas, Texas 75243**

**Notification# 20180221003  
Datasheet for OPA211, OPA2211  
Information Only**

**Date:** February 22, 2018  
**To:** TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager ([PCN\\_ww\\_admin\\_team@list.ti.com](mailto:PCN_ww_admin_team@list.ti.com)).

Sincerely,

PCN Team  
SC Business Services


## Information Only Attachments

### Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
OPA211AIDR	null
OPA2211AIDDA	null
OPA211AID	null
OPA211AIDGKT	null
OPA211ID	null
OPA2211AIDRGT	null
OPA211IDR	null

Technical details of this Product Change follow on the next page(s).

<b>PCN Number:</b>	20180221003	<b>PCN Date:</b>	February 22, 2018																												
<b>Title:</b>	Datasheet for OPA211, OPA2211																														
<b>Customer Contact:</b>	<a href="#">PCN Manager</a>	<b>Dept:</b>	Quality Services																												
<b>Change Type:</b>																															
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site																													
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material																													
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process																													
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site																													
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials																													
		<input type="checkbox"/> Wafer Fab Process																													
<b>Notification Details</b>																															
<b>Description of Change:</b>																															
<p>Texas Instruments Incorporated is announcing an information only notification.  The product datasheet(s) is being updated as summarized below.  The following change history provides further details.</p>																															
<div style="display: flex; justify-content: space-between; align-items: center;">  <div style="text-align: right;"> <b>OPA211, OPA2211</b>  <small>SBOS377J–OCTOBER 2006–REVISED FEBRUARY 2018</small> </div> </div>																															
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The datasheet number will be changing.																															
Device Family	Change From:	Change To:																													
OPA211, OPA2211	SBOS377I	SBOS377J																													
<p>These changes may be reviewed at the datasheet links provided.  <a href="http://www.ti.com/product/OPA211">http://www.ti.com/product/OPA211</a></p>																															
<b>Reason for Change:</b>																															
To accurately reflect device characteristics.																															
<b>Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):</b>																															
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.																															
<b>Changes to product identification resulting from this PCN:</b>																															
None.																															

<b>Product Affected:</b>			
OPA211AID	OPA211AIDR	OPA211ID	OPA211IDRGT
OPA211AIDG4	OPA211AIDRG4	OPA211IDGKR	OPA2211AIDDA
OPA211AIDGKR	OPA211AIDRGR	OPA211IDGKT	OPA2211AID DAR
OPA211AIDGKT	OPA211AIDRGT	OPA211IDR	OPA2211AIDRGR
OPA211AIDGKTG4	OPA211AIDRGTG4	OPA211IDRGR	OPA2211AIDRGT

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

<b>Location</b>	<b>E-Mail</b>
USA	<a href="mailto:PCNAmericasContact@list.ti.com">PCNAmericasContact@list.ti.com</a>
Europe	<a href="mailto:PCNEuropeContact@list.ti.com">PCNEuropeContact@list.ti.com</a>
Asia Pacific	<a href="mailto:PCNAsiaContact@list.ti.com">PCNAsiaContact@list.ti.com</a>
Japan	<a href="mailto:PCNJapanContact@list.ti.com">PCNJapanContact@list.ti.com</a>